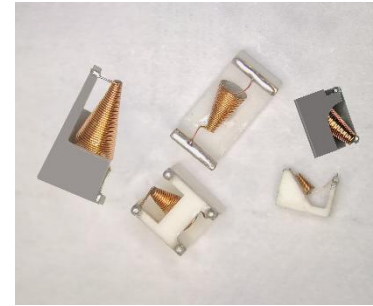


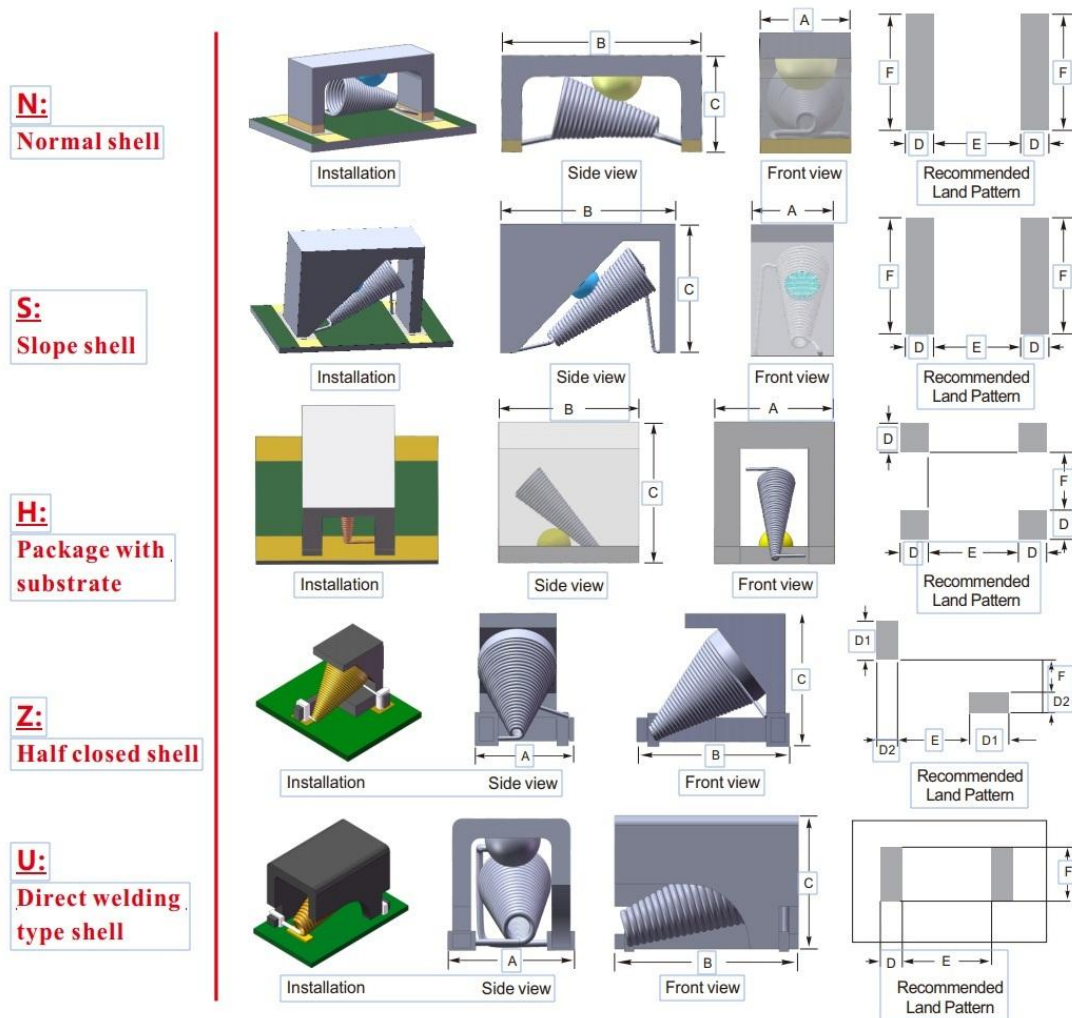
## SMT Broadband Conical Inductors

### FEATURES

- ◆ Broadband performance over 53+ GHz
- ◆ Strong current processing capacity
- ◆ Low insertion loss across frequency bands
- ◆ Suitable for small volumes and surface mount applications



### INSTALLATION DIAGRAM FOR THE HOUSING TYPE



### ORDER INFORMATION

**VM0301M0016N840-LPW**

**L: Shell type** (N:Normal shell S:Slope shell H:Package with substrate Z:Half closed shell U:Direct welding type shell)  
**P: Inductor package size:** A\*B\*C corresponds to width \* length \* height;  
**W: Inductor soldering parameters:**  
 D\*E\*F corresponds to pad size \* pad long pitch \* pad wide pitch

The tolerance  $\pm 0.05$  is not marked. The contents of the specification are subject to update without notice. Please contact the consultant or confirm the technical parameters on the official website before ordering. PS: Special models can be customized as required.

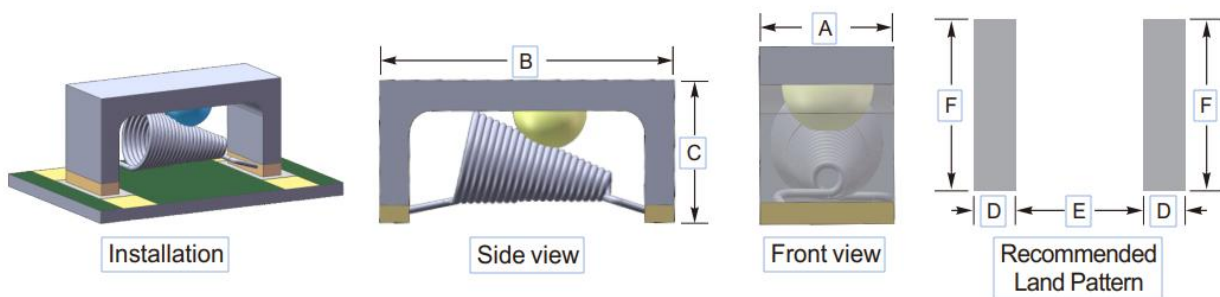
## Conventional cover housing encapsulated broadband conical inductor (N series)



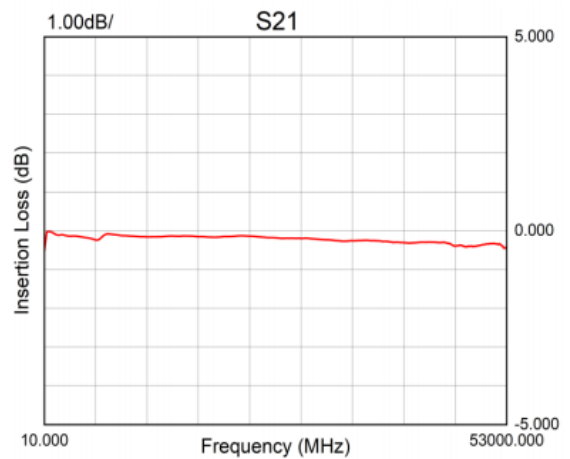
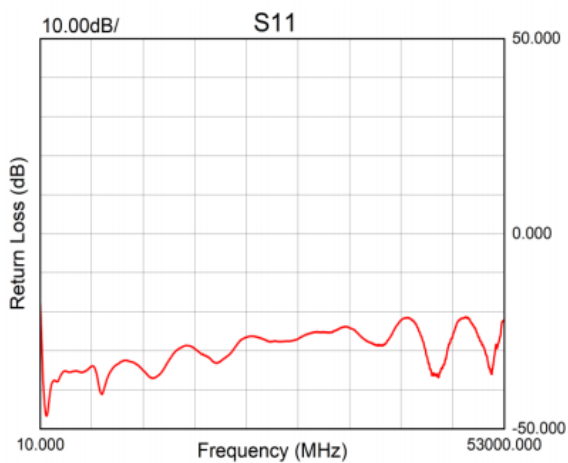
### FEATURES

- ◆ Excellent electrical insulation
- ◆ Simplified structure and miniaturized size
- ◆ Ultra-wideband applications, with outstanding high-frequency performance
- ◆ High mechanical strength and high bonding capacity of solder joints
- ◆ The flat structure reduces parasitic capacitance and results in low signal loss
- ◆ Thermal management and reliability improvement enhance temperature stability Miniaturized and standardized packaging, compatible with SMT automation, reduces assembly costs

### INSTALLATION DIAGRAM FOR THE HOUSING TYPE



### FREQUENCY RESPONSE



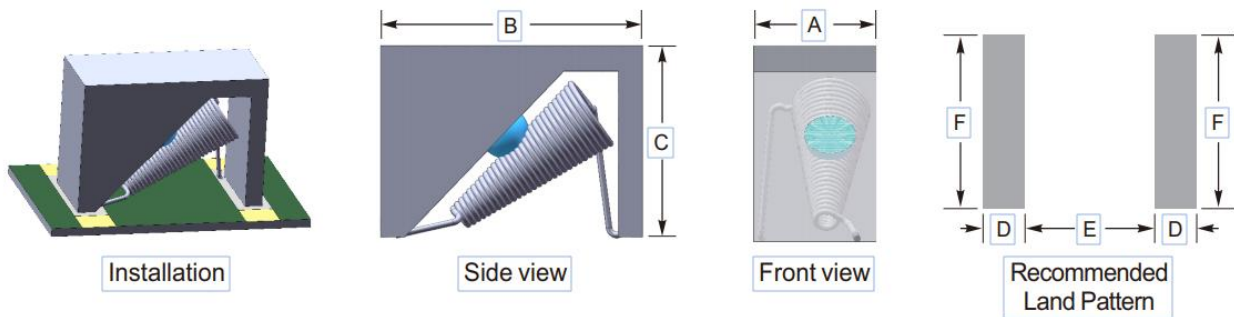
# Wideband Conical Inductors with Slope Cover Shell (S series)



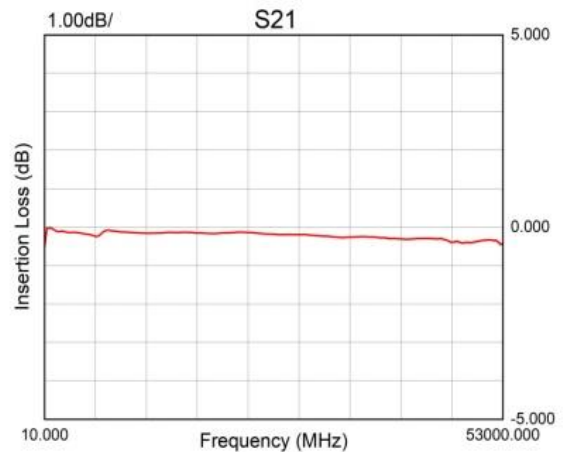
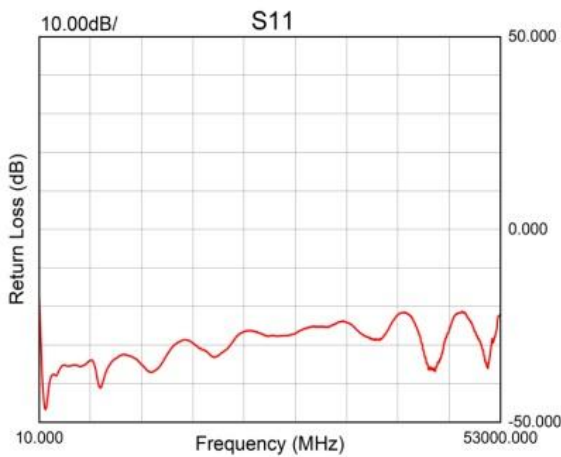
## FEATURES

- Excellent high-frequency impedance characteristics
- Simplified structure and miniaturized size
- Ultra-wideband applications, with outstanding high-frequency performance
- Ceramic packaging provides excellent dielectric shielding
- Make sure the installation Angle is close to the board surface
- Thermal management and reliability improvement enhance temperature stability
- Miniaturized and standardized packaging, compatible with SMT automation, reduces assembly costs

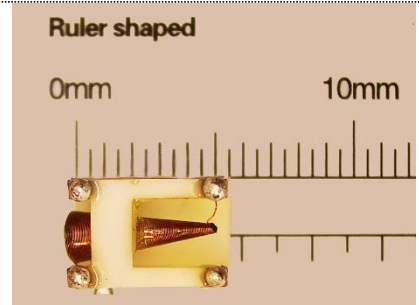
## INSTALLATION DIAGRAM FOR THE HOUSING TYPE



## FREQUENCY RESPONSE



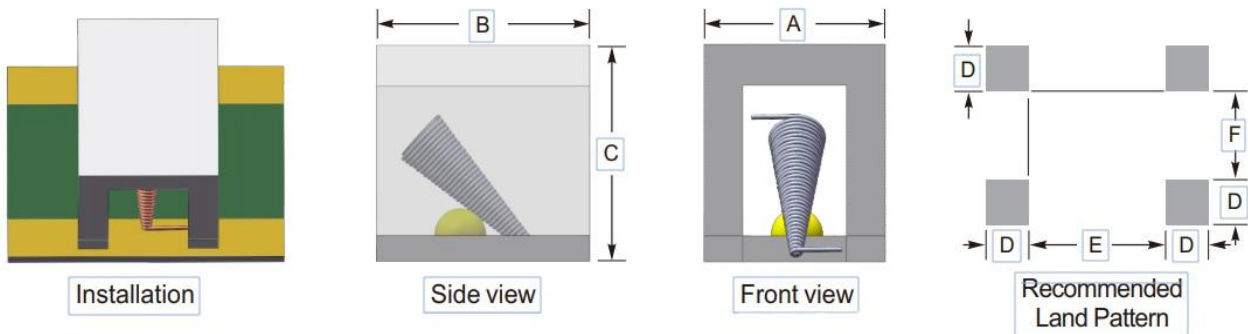
# Broadband Conical Inductors with Substrate Packaging (H series)



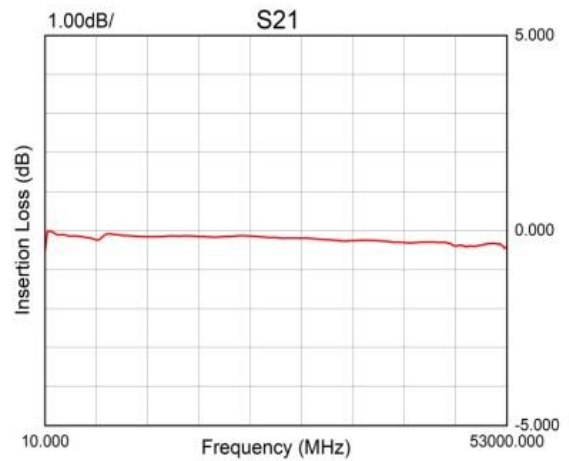
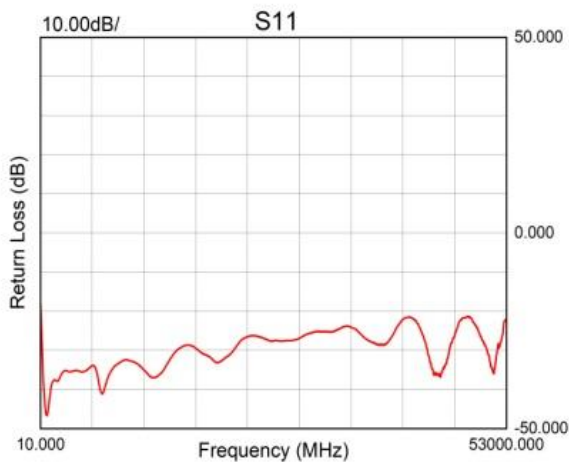
## FEATURES

- ◆ The support body maintains a stable Angle
- ◆ Simplified structure and miniaturized size
- ◆ Ultra-wideband applications, with outstanding high-frequency performance
- ◆ Ceramic packaging provides excellent dielectric shielding
- ◆ High heat conduction efficiency
- ◆ Thermal management and reliability improvement enhance temperature stability
- ◆ Miniaturized and standardized packaging, compatible with SMT automation, reduces assembly costs

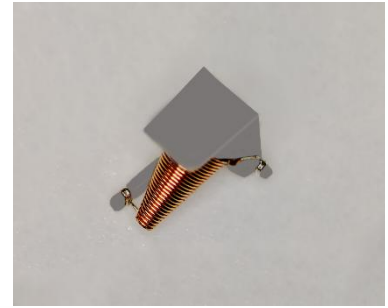
## INSTALLATION DIAGRAM FOR THE HOUSING TYPE



## FREQUENCY RESPONSE



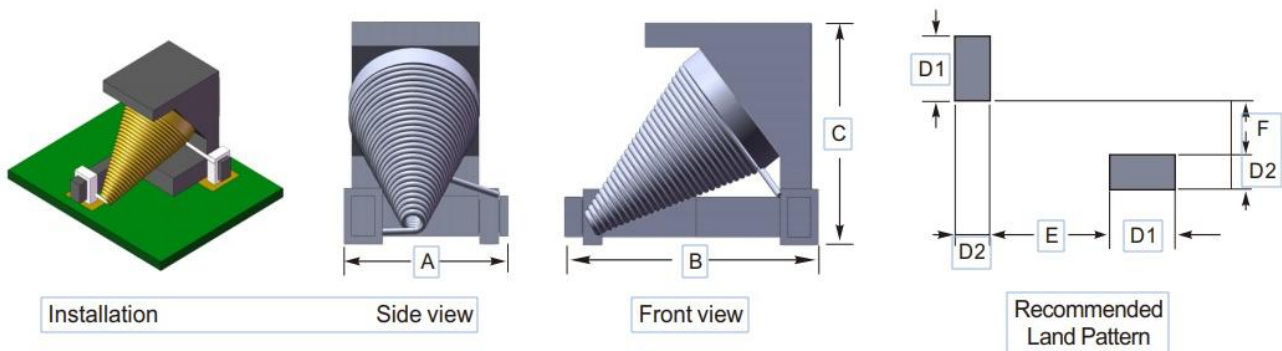
# Half-enclosed packaged broadband conical inductor (Z series)



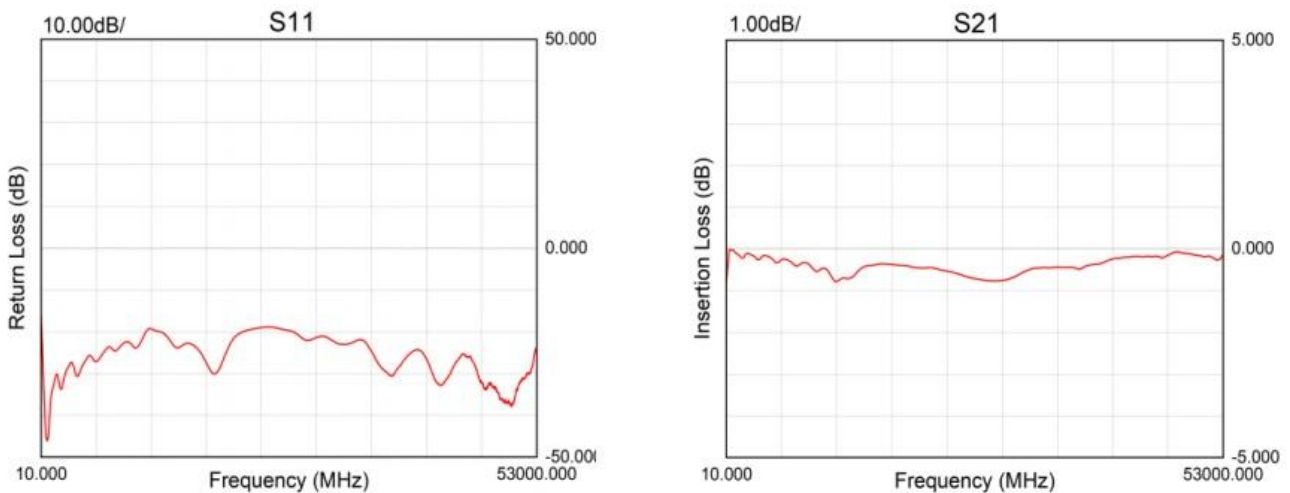
## FEATURES

- Simplified structure and miniaturized size
- The solder joint gap is controllable, reducing the noise of the line arc
- Ultra-wideband applications, with outstanding high-frequency performance
- The magnetic core is fully encapsulated to prevent oxidation
- The solder joint gap is controllable, reducing the noise of the line arc
- Thermal management and reliability improvement enhance temperature stability
- Miniaturized and standardized packaging, compatible with SMT automation, reduces assembly costs

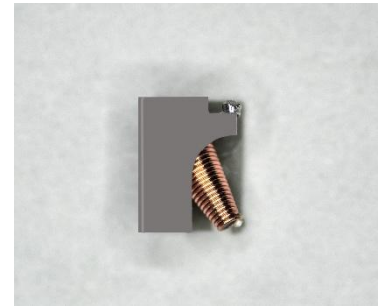
## INSTALLATION DIAGRAM FOR THE HOUSING TYPE



## FREQUENCY RESPONSE



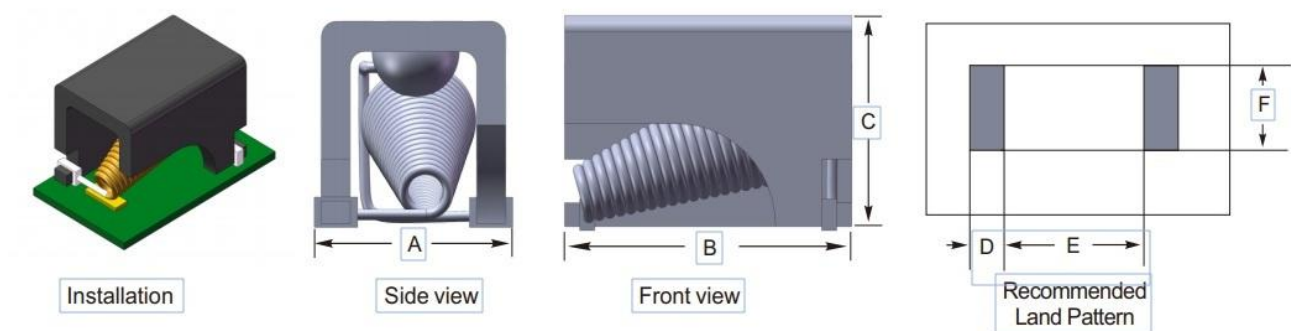
## Direct-welded cover type broadband conical inductor (U series)



### FEATURES

- ◆ Anti-parasitic design
- ◆ Low insertion loss (< 0.5dB)
- ◆ Supports reflow soldering installation
- ◆ Ultra-wideband application (~53GHz)
- ◆ Optimized processing procedure of welding points, highly integrated in space
- ◆ It features an extremely optimal volume ratio, enabling high-density applications

### INSTALLATION DIAGRAM FOR THE HOUSING TYPE



### FREQUENCY RESPONSE

